

中国电子元件相关 GB 标准 100 条

- 1 GB/T 1772-1979 电子元器件失效率试验方法 Determination of failure rate of electronic elements and components
- 2 GB/T 2036-1994 印制电路术语 Terms for printed circuits
- 3 GB/T 2413-1980 压电陶瓷材料体积密度测量方法 Piezoelectric ceramic materials--Measuring methods for determination of volume density
- 4 GB/T 2470-1995 电子设备用固定电阻器、固定电容器型号命名方法 Type designation system for fixed resistors and fixed capacitors for use in electronic equipment
- 5 GB/T 2471-1995 电阻器和电容器优先数系 Preferred number series for resistors and capacitors
- 6 GB/T 2472-1981 电子设备用固定式电容器工作电压系列 Fixed capacitors for electronic equipments--Working voltage series
- 7 GB/T 2473-1981 电子设备用矩形金属外壳电容器外形尺寸系列 Capacitors with rectangular metal enclosure for electronic equipments--Outline dimensions series
- 8 GB/T 2474-1981 电子设备用圆形金属外壳电容器外形尺寸系列 Capacitors with disc metal enclosure for electronic equipments--Outline dimensions series
- 9 GB/T 2658-1995 小型交流风通用机技术条件 A.C. miniature blowers, general specification for
- 10 GB/T 2693-1990 电子设备用固定电容器 第一部分：总规范（可供认证用） Fixed capacitors for use in electronic equipment-Part 1: Generic specification
- 11 GB/T 2775-1993 手控电子元件的轴端尺寸 Dimensions of spindle ends for manually operated electronic components
- 12 GB/T 3351-1982 人造石英晶体的型号命名 Designations for synthetic quartz crystals
- 13 GB/T 3388-1982 压电陶瓷材料型号命名方法 Designations for types of piezoelectric ceramics
- 14 GB/T 3389.3-1982 压电陶瓷材料性能测试方法 居里温度 T_c 的测试 Test methods for the properties of piezoelectric ceramics--Test for Curie temperature T_c

- 15 GB/T 3389.4-1982 压电陶瓷材料性能测试方法 柱体纵向长度伸缩振动模式 Test methods for the properties of piezoelectric ceramics--Longitudinal length extension vibration mode for rod
- 16 GB/T 3389.7-1986 压电陶瓷材料性能测试方法 强场介电性能的测试 Test methods for the properties of piezoelectric ceramics--Test for dielectric properties in high electric field
- 17 GB/T 3389.8-1986 压电陶瓷材料性能测试方法 热释电系数的测试 Test methods for the properties of piezoelectric ceramics--Test for the pyroelectric coefficient
- 18 GB/T 3664-1986 电容器非线性测量方法 Method of measurement of non-linearity in capacitors
- 19 GB/T 3788-1995 真空电容器通用技术条件 General specification for vacuum capacitors
- 20 GB/T 4071-1983 光致荧光粉测试方法 Measuring method for the phosphor excited by light
- 21 GB/T 4072-1983 阴极射线致荧光粉测试方法 Measuring method of the phosphor excited by cathode rays
- 22 GB/T 4098.1-1983 射频电缆电晕试验方法 Test method of corona for radio-frequency cables
- 23 GB/T 4098.2-1983 射频电缆电容和电容不平衡测量方法 Methods of measurement of capacitance and capacitance unbalance for radio-frequency cables
- 24 GB/T 4098.3-1983 射频电缆特性阻抗测量方法 Methods of measurement of characteristic impedance for radio-frequency cables
- 25 GB/T 4098.4-1983 射频电缆衰减常数测量方法 Methods of measurement of attenuation constant for radio-frequency cables
- 26 GB/T 4098.5-1983 射频电缆电容稳定性试验方法 Test method of capacitance stability for radio-frequency cables
- 27 GB/T 4098.6-1983 射频电缆衰减稳定性试验方法 Test method of attenuation stability for radio-frequency cables
- 28 GB/T 4098.7-1983 射频电缆高温试验方法 Test method of high-temperature for radio-frequency cables
- 29 GB/T 4098.8-1983 射频电缆低温试验方法 Test method of low-temperature for radio-frequency cables

- 30 GB/T 4098.9-1983 射频电缆流动性试验方法 Test method of flow for radio-frequency cables
- 31 GB/T 4098.10-1983 射频电缆尺寸稳定性试验方法 Test method of dimensional stability for radio-frequency cables
- 32 GB/T 4165-1984 电子设备用可变电容器的使用导则 Guide to the use of variable capacitors in electronic equipment
- 33 GB/T 4166-1984 电子设备用可变电容器的试验方法 Methods of test of variable capacitors in electronic equipment
- 34 GB/T 4210-1984 电子设备用机电元件名词术语 Terms of electromechanical components for electronic equipment
- 35 GB/T 4475-1995 敏感元器件术语 Terms of sensor
- 36 GB/T 4588.1-1996 无金属化孔单双面印制板分规范 Sectional specification: single and double sided printed boards with plain holes
- 37 GB/T 4588.2-1996 有金属化孔单双面印制板分规范 Sectional specification: single and double sided printed boards with plated-through holes
- 38 GB/T 4588.3-1988 印制电路板设计和使用 Design and use of printed boards
- 39 GB/T 4588.4-1996 多层印制板 分规范 Sectional specification--Multilayer printed boards
- 40 GB/T 4588.10-1995 印制板 第 10 部分: 有贯穿连接的刚挠双面印制板规范 Printed boards--Part 10: Specification for flex-rigid double-sided printed boards with through connections
- 41 GB/T 4596-1984 电子设备用三相变压器形铁心 E-cores for three-phase transformers for use in electronic equipment
- 42 GB/T 4677.1-1984 印制板表层绝缘电阻测试方法 Test method of surface insulation resistance for printed boards
- 43 GB/T 4677.2-1984 印制板金属化孔镀层厚度测试方法 微电阻法 Micro-resistance test method of plating thickness of platedthrough holes for printed boards
- 44 GB/T 4677.3-1984 印制板拉脱强度测试方法 Test methods of pull strength for printed boards
- 45 GB/T 4677.4-1984 印制板抗剥强度测试方法 Test methods of peel strength for printed boards

- 46 GB/T 4677.5-1984 印制板翘曲度测试方法 Test methods of flatness for printed boards
- 47 GB/T 4677.6-1984 金属和氧化覆盖层厚度测试方法 截面金相法 Test methods for thickness of metal and oxide coating by microscopical examination of cross-section
- 48 GB/T 4677.7-1984 印制板镀层附着力试验方法 胶带法 Test method of plating adhesion by adhesive type for printed boards
- 49 GB/T 4677.8-1984 印制板镀涂覆层厚度测试方法 反向散射法 Test method of plating and coating thickness by beta backscattering for printed boards
- 50 GB/T 4677.9-1984 印制板镀层孔隙率电象测试方法 The electrographic test method of plating porosity for printed boards
- 51 GB/T 4677.10-1984 印制板可焊性测试方法 Test method of solderability for printed boards
- 52 GB/T 4677.11-1984 印制板耐热冲击试验方法 Test methods of thermal shock for printed boards
- 53 GB/T 4677.12-1988 印制板互连电阻测试方法 Test method of interconnection resistance for printed boards
- 54 GB/T 4677.13-1988 印制板金属化孔电阻的变化 热循环测试方法 Test method of change in resistance of plated-through holes--Thermal cycling for printed boards
- 55 GB/T 4677.14-1988 印制板蒸汽-氧气加速老化试验方法 Test method of steam/oxygen accelerated ageing of printed board
- 56 GB/T 4677.15-1988 印制板绝缘涂层耐溶剂和耐焊剂试验方法 Test method for solvent and flux resistance of insulating coating on printed boards
- 57 GB/T 4677.16-1988 印制板一般检验方法 General examination method for printed boards
- 58 GB/T 4677.17-1988 多层印制板内层绝缘电阻测试方法 Test method for insulation resistance within inner layers of multilayer printed boards
- 59 GB/T 4677.18-1988 多层印制板层间绝缘电阻测试方法 Test method for insulation resistance between layers of multilayer printed boards
- 60 GB/T 4677.19-1988 印制板电路完善性测试方法 Test method for electrical integrity of printed boards
- 61 GB/T 4677.20-1988 印制板镀层附着性试验方法 摩擦法 Test method for plating adhesion of printed boards—Burnishing

- 62 GB/T 4677.21-1988 印制板镀层孔隙率测试方法 气体暴露法 Test method for plating porosity of printed boards--The gas exposure method
- 63 GB/T 4677.22-1988 印制板表面离子污染测试方法 Test method for surface ionic contamination of printed boards
- 64 GB/T 4677.23-1988 印制板阻燃性能测试方法 Test method for flammability of printed boards
- 65 GB/T 4721-1992 印制电路用覆铜箔层压板通用规则 General rules for copper-clad laminated sheets for printed circuits
- 66 GB/T 4722-1992 印制电路用覆铜箔层压板试验方法 Test methods for copper-clad laminated sheets for printed circuits
- 67 GB/T 4723-1992 印制电路用覆铜箔酚醛纸层压板 Phenolic cellulose paper copper-clad laminated sheets for printed circuits
- 68 GB/T 4724-1992 印制电路用覆铜箔环氧纸层压板 Epoxide cellulose paper copper-clad laminated sheets for printed circuits
- 69 GB/T 4725-1992 印制电路用覆铜箔环氧玻璃布层压板 Epoxide woven glass fabric copper-clad laminated sheets for printed circuits
- 70 GB/T 4779.1-1984 彩色显象管用荧光粉 Y22-G3 荧光粉 Phosphors for color picture tubes use--Phosphor Y22-G3
- 71 GB/T 4779.2-1984 彩色显象管用荧光粉 Y22-B2 荧光粉 Phosphors for color picture tubes use--Phosphor Y22-B2
- 72 GB/T 4779.3-1984 彩色显象管用荧光粉 Y22-R4 荧光粉 Phosphors for color picture tubes use--Phosphor Y22-R4
- 73 GB/T 4825.1-1984 印制板导线局部放电测试方法 Test method for partial discharge of conductors on printed boards
- 74 GB/T 4825.2-1984 印制板导线载流量测试方法 Test method for current carrying capacity of conductors on printed boards
- 75 GB/T 4874-1985 直流固定金属化纸介电容器总规范 Generic specification for fixed metallized paper dielectric capacitors for direct current
- 76 GB/T 5076-1985 具有两个轴向引出端的圆柱体元件的尺寸测量 Measurement of the dimensions of a cylindrical component having two axial terminations

77 GB/T 5077-1985 电容器和电阻器的最大外形尺寸 Maximum case dimensions for capacitors and resistors

78 GB/T 5078-1985 单向引出的电容器和电阻器所需空间的测定方法 Method for the determination of the space required by capacitors and resistors with unidirectional terminations

79 GB/T 5489-1985 印制板制图 Printed board drawing

80 GB/T 5594.1-1985 电子元器件结构陶瓷材料性能测试方法 气密性测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for gas-tightness

81 GB/T 5594.2-1985 电子元器件结构陶瓷材料性能测试方法 杨氏弹性模量、泊松比测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for Youngs elastic modulus and Poisson ratio

82 GB/T 5594.3-1985 电子元器件结构陶瓷材料性能测试方法 平均线膨胀系数测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for mean coefficient of linear expansion

83 GB/T 5594.4-1985 电子元器件结构陶瓷材料性能测试方法 介质损耗角正切值的测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for dielectric loss angle tangent value

84 GB/T 5594.5-1985 电子元器件结构陶瓷材料性能测试方法 体积电阻率测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for volume resistivity

85 GB/T 5594.6-1985 电子元器件结构陶瓷材料性能测试方法 化学稳定性测试方法 Test methods for properties of structure ceramic used in electronic components--Test method for chemical durability

86 GB/T 5594.7-1985 电子元器件结构陶瓷材料性能测试方法 透液性测定方法 Test methods for properties of structure ceramic used in electronic components--Test method for liquid permeability

87 GB/T 5594.8-1985 电子元器件结构陶瓷材料性能测试方法 显微结构的测定 Test methods for properties of structure ceramic used in electronic components--Determination of microstructure

88 GB/T 5598-1985 氧化铍瓷导热系数测定方法 Test method for thermal conductivity of beryllium oxide ceramics

89 GB/T 5729-1994 电子设备用固定电阻器 第一部分: 总规范 Fixed resistors for use in electronic equipment--Part 1: Generic specification

90 GB/T 5730-1985 电子设备用固定电阻器 第二部分: 分规范: 低功率非线性绕固定电阻器 (可供认证用) Fixed resistors for use in electronic equipment--Part 2: Sectional specification: Fixed low-power non-wire wound resistors

91 GB/T 5731-1985 电子设备用固定电阻器 第二部分: 空白详细规范: 低功率非线性绕固定电阻器评定水平 E (可供认证用) Fixed resistors for use in electronic equipment--Part 2: Blank detail specification: Fixed low-power non-wire wound resistors--Assessment level E

92 GB/T 5732-1985 电子设备用固定电阻器 第四部分: 分规范: 功率型固定电阻器(可供认证用) Fixed resistors for use in electronic equipment--Part 4: Sectional specification: Fixed power resistors

93 GB/T 5733-1985 电子设备用固定电阻器 第四部分: 空白详细规范: 功率型固定电阻器评定水平 E (可供认证用) Fixed resistors for use in electronic equipment--Part 4: Blank detail specification: Fixed power resistors Assessment level E

94 GB/T 5734-1985 电子设备用固定电阻器 第五部分: 分规范: 精密固定电阻器 (可供认证用) Fixed resistors for use in electronic equipment--Part 5: Sectional specification: Fixed precision resistors

95 GB/T 5735-1985 电子设备用固定电阻器 第五部分: 空白详细规范: 精密固定电阻器 评定水平 E (可供认证用) Fixed resistors for use in electronic equipment--Part 5: Blank detail specification: Fixed precision resistors--Assessment level E

96 GB/T 5838-1986 荧光粉名词术语 Terms for phosphors

97 GB/T 5966-1996 电子设备用固定电容器 第 8 部分: 分规范: 1 类瓷介固定电容器 Fixed capacitors for use in electronic equipment--Part 8: Sectional specification: Fixed capacitors of ceramic dielectric, class 1

98 GB/T 5967-1996 电子设备用固定电容器 第 8 部分: 空白详细规范 1 类瓷介固定电容器 评定水平 E Fixed capacitors for use in electronic equipment--Part 8: Blank detail specification Fixed capacitors of ceramic dielectric, class 1--Assessment level E

99 GB/T 5968-1996 电子设备用固定电容器 第 9 部分: 分规范 2 类瓷介固定电容器 Fixed capacitors for use in electronic equipment--Part 9: Sectional specification Fixed capacitors of ceramic dielectric, class 2

100 GB/T 5969-1996 电子设备用固定电容器 第 9 部分: 空白详细规范 2 类瓷介电容器 评定水平 E Fixed capacitors for use in electronic equipment--Part 9: Blank detail specification Fixed capacitor of ceramic dielectric, class 2 --Assessment level E



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